# DATA SHEET

# 74ALVT16501

2.5V/3.3V 18-bit universal bus transceiver (3-State)

Product specification Supersedes data of 1997 May 01 IC23 Data Handbook





### 2.5V/3.3V 18-bit universal bus transceiver (3-State)

#### 74ALVT16501

#### **FEATURES**

- 18-bit bidirectional bus interface
- 5V I/O Compatible
- 3-State buffers
- Output capability: +64mA/-32mA
- TTL and LVTTL input and output switching levels
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power-up reset
- Power-up 3-State
- No bus current loading when output is tied to 5V bus
- Positive edge triggered clock inputs
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 400V per Machine Model

#### **DESCRIPTION**

The 74ALVT16501 is a high-performance BiCMOS product designed for  $\rm V_{CC}$  operation at 2.5V and 3.3V with I/O compatibility up to 5V.

This device is an 18-bit universal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. Data flow in each direction is controlled by output enable (OEAB and OEBA), latch enable (LEAB and LEBA), and clock (CPAB and CPBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is High. When LEAB is Low, the A data is latched if CPAB is held at a High or Low logic level. If LEAB is Low, the A-bus data is stored in the latch/flip-flop on the Low-to-High transition of CPAB. When OEAB is High, the outputs are active. When OEAB is Low, the outputs are in the high-impedance state.

Data flow for B-to-A is similar to that of A-to-B but uses  $\overline{\text{OEBA}}$ , LEBA and CPBA. The output enables are complimentary (OEAB is active High, and  $\overline{\text{OEBA}}$  is active Low).

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

#### **QUICK REFERENCE DATA**

CVMDOL	PARAMETER	CONDITIONS	TYPI	LIAUT	
SYMBOL	PARAMETER	T <sub>amb</sub> = 25°C	2.5V	3.3V	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn or Bn to An	C <sub>L</sub> = 50pF	1.9 2.5	1.4 1.8	ns
C <sub>IN</sub>	Input capacitance (Control pins)	$V_I = 0V \text{ or } V_{CC}$	4	4	pF
C <sub>I/O</sub>	I/O pin capacitance	V <sub>I/O</sub> = 0V or V <sub>CC</sub>	8	8	pF
I <sub>CCZ</sub>	Total supply current	Outputs disabled	40	60	μΑ

#### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
56-Pin Plastic SSOP Type III	-40°C to +85°C	74ALVT16501 DL	AV16501 DL	SOT371-1
56-Pin Plastic TSSOP Type II	–40°C to +85°C	74ALVT16501 DGG	AV16501 DGG	SOT364-1

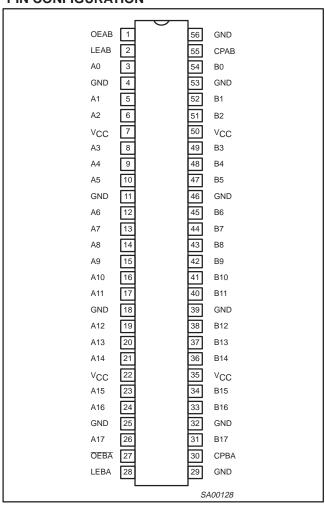
#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	OEAB	A-to-B Output enable input
27	ŌEBĀ	B-to-A Output enable input (active low)
2, 28	LEAB/LEBA	A-to-B/B-to-A Latch enable input
55,30	CPAB/CPBA	A-to-B/B-to-A Clock input (active rising edge)
3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26	A0-A17	Data inputs/outputs (A side)
54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31	B0-B17	Data inputs/outputs (B side)
4, 11, 18, 25, 32, 39, 46, 53, 29, 56	GND	Ground (0V)
7, 22, 35, 50	V <sub>CC</sub>	Positive supply voltage

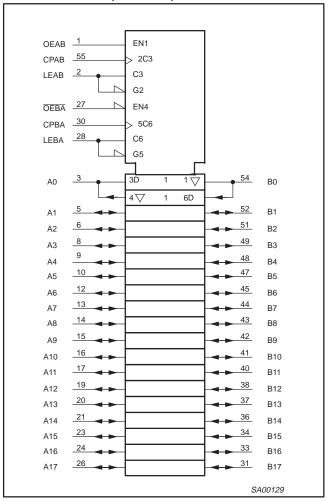
# 2.5V/3.3V 18-bit universal bus transceiver (3-State)

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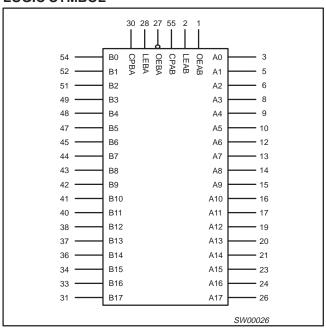
#### **PIN CONFIGURATION**



#### LOGIC SYMBOL (IEEE/IEC)



#### **LOGIC SYMBOL**



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#### **FUNCTION TABLE**

	INP	UTS		Internal	OUTPUTS	OPERATING MODE
OEAB	LEAB	СРАВ	An	Registers	Bn	
L	Н	Х	Х	Х	Z	Disabled
L	$\downarrow$	Х	h	Н	Z	Dischlad Lateh data
L	$\downarrow$	Х	I	L	Z	Disabled, Latch data
L	L	H or L	Х	NC	Z	Disabled, Hold data
L	L	1	h	Н	Z	Dischlad Clask data
L	L	1	ı	L	Z	Disabled, Clock data
Н	Н	Х	Н	Н	Н	Transparent
Н	Н	Х	L	L	L	Transparent
Н	$\downarrow$	Х	h	Н	Н	Latch data & display
Н	$\downarrow$	Х	I	L	L	Lateri data & dispiay
Н	L	1	h	Н	Н	Clock data 9 diambu
Н	L	1	I	L	L	Clock data & display
Н	L	H or L	Х	Н	Н	Hold data & diaplay
Н	L	H or L	Х	L	L	Hold data & display

NOTE: A-to-B data flow is shown; B-to-A flow is similar but uses OEBA, LEBA, and CPBA.

H = High voltage level h = High voltage level one set-up time prior to the Enable or Clock transition

L = Low voltage level

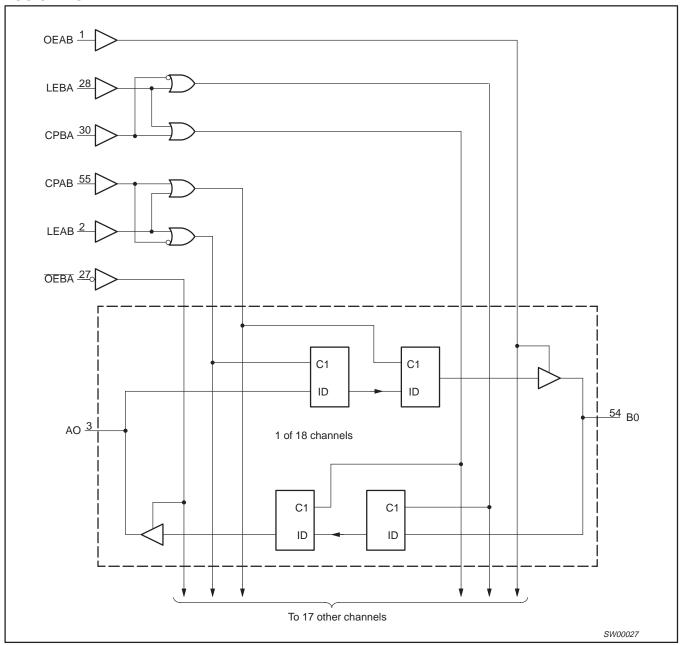
I = Low voltage level one set-up time prior to the Enable or Clock transition NC= No Change

X = Don't care
Z = High Impedence "off" state
↓ = High-to-Low Enable or Clock transition

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#### **LOGIC DIAGRAM**



# 2.5V/3.3V 18-bit universal bus transceiver (3-State)

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### ABSOLUTE MAXIMUM RATINGS 1, 2

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +4.6	V
I <sub>IK</sub>	DC input diode current	V <sub>I</sub> < 0	-50	mA
VI	DC input voltage <sup>3</sup>		-0.5 to +7.0	V
lok	DC output diode current	V <sub>O</sub> < 0	-50	mA
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	Output in Off or High state	-0.5 to +7.0	V
leu-	DC output current	Output in Low state	128	mA
Гоит	Do output current	Output in High state	-64	III/A
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C

#### NOTES

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	2.5V RANG	GE LIMITS	3.3V RANG	UNIT	
STWIDOL	TANAMETER	MIN	MAX	MIN	MAX	ONIT
V <sub>CC</sub>	DC supply voltage	2.3	2.7	3.0	3.6	V
V <sub>I</sub>	Input voltage	0	5.5	0	5.5	V
V <sub>IH</sub>	High-level input voltage	1.7		2.0		V
V <sub>IL</sub>	Input voltage		0.7		0.8	V
Іон	High-level output current		-8		-32	mA
la.	Low-level output current		8		32	mA
lol	Low-level output current; current duty cycle ≤ 50%; f ≥ 1kHz		24		64	IIIA
Δt/Δν	Input transition rise or fall rate; Outputs enabled		10		10	ns/V
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	-40	+85	°C

<sup>1.</sup> Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>2.</sup> The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

<sup>3.</sup> The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

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### DC ELECTRICAL CHARACTERISTICS (3.3V $\pm$ 0.3V RANGE)

		TEST CONDITIONS			LIMITS		
SYMBOL	PARAMETER			Temp = -40°C to		+85°C	UNIT
				MIN	TYP <sup>1</sup>	MAX	1
V <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = 3.0V; I <sub>IK</sub> = -18mA			-0.85	-1.2	V
\/	Library Laurent Contraction of the Contraction of t	$V_{CC} = 3.0 \text{ to } 3.6 \text{V}; I_{OH} = -100 \mu\text{A}$		V <sub>CC</sub> -0.2	V <sub>CC</sub>		V
V <sub>OH</sub>	High-level output voltage	$V_{CC} = 3.0V; I_{OH} = -32mA$		2.0	2.3		l
		$V_{CC} = 3.0V; I_{OL} = 100\mu A$			0.07	0.2	
17	l and land and and and	V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 16mA			0.25	0.4	. v
$V_{OL}$	Low-level output voltage	V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 32mA			0.3	0.5	l
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 64mA			0.4	0.55	1
V <sub>RST</sub>	Power-up output low voltage <sup>6</sup>	$V_{CC} = 3.6V$ ; $I_O = 1mA$ ; $V_I = V_{CC}$ or GND				0.55	V
		$V_{CC} = 3.6V$ ; $V_I = V_{CC}$ or GND	Control pins		0.1	±1	
		V <sub>CC</sub> = 0 or 3.6V; V <sub>I</sub> = 5.5V			0.1	10	
I <sub>I</sub>	I <sub>I</sub> Input leakage current	V <sub>CC</sub> = 3.6V; V <sub>I</sub> = 5.5V			0.1	20	μΑ
		V <sub>CC</sub> = 3.6V; V <sub>I</sub> = V <sub>CC</sub>	Data pins <sup>4</sup>		0.5	10	
		$V_{CC} = 3.6V; V_I = 0V$	1		0.1	-5	
I <sub>OFF</sub>	Off current	$V_{CC} = 0V$ ; $V_{I}$ or $V_{O} = 0$ to 4.5V			0.1	±100	μΑ
	Due Held current	$V_{CC} = 3V; V_{I} = 0.8V$		75	130		
I <sub>HOLD</sub>	Bus Hold current	V <sub>CC</sub> = 3V; V <sub>I</sub> = 2.0V		-75	-140		μΑ
	Data inputs <sup>7</sup>	$V_{CC} = 0V \text{ to } 3.6V; V_{CC} = 3.6V$		±500			1
I <sub>EX</sub>	Current into an output in the High state when V <sub>O</sub> > V <sub>CC</sub>	V <sub>O</sub> = 5.5V; V <sub>CC</sub> = 3.0V			10	125	μА
I <sub>PU/PD</sub>	Power up/down 3-State output current <sup>3</sup>	$V_{CC} \le 1.2V$ ; $V_O = 0.5V$ to $V_{CC}$ ; $V_I = GNE$ OE/OE = Don't care	$V_{CC} \le 1.2V$ ; $V_O = 0.5V$ to $V_{CC}$ ; $V_I = GND$ or $V_{CC}$ OE/OE = Don't care		1.0	±100	μΑ
Іссн		$V_{CC} = 3.6V$ ; Outputs High, $V_I = GND$ or $V_{CC}$ , $I_{O} = 0$			0.06	0.1	
I <sub>CCL</sub>	Quiescent supply current	$V_{CC}$ = 3.6V; Outputs Low, $V_I$ = GND or $V_{CC}$ , $I_O$ = 0			3.5	5	mA
I <sub>CCZ</sub>	1	V <sub>CC</sub> = 3.6V; Outputs Disabled; V <sub>I</sub> = GNE	or $V_{CC}$ , $I_{O} = 0^5$		0.06	0.1	
Δl <sub>CC</sub>	Additional supply current per input pin <sup>2</sup>	$V_{CC}$ = 3V to 3.6V; One input at $V_{CC}$ -0.6 Other inputs at $V_{CC}$ or GND	V,		0.04	0.4	mA

#### NOTES:

- All typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.
   This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND
   This parameter is valid for any V<sub>CC</sub> between 0V and 1.2V with a transition time of up to 10msec. From V<sub>CC</sub> = 1.2V to V<sub>CC</sub> = 3.3V ± 0.3V a transition time of 100µsec is permitted. This parameter is valid for T<sub>amb</sub> = 25°C only.
   Unused pins at V<sub>CC</sub> or GND.

- I<sub>CCZ</sub> is measured with outputs pulled up to V<sub>CC</sub> or pulled down to ground.
   For valid test results, data must not be loaded into the flip-flops (or latches) after applying power.
   This is the bus hold overdrive current required to force the input to the opposite logic state.

# 2.5V/3.3V 18-bit universal bus transceiver (3-State)

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#### AC CHARACTERISTICS (3.3V $\pm$ 0.3V RANGE)

GND = 0V;  $t_R = t_F = 2.5 \text{ns}$ ;  $C_L = 50 \text{pF}$ ;  $R_L = 500 \Omega$ ;  $T_{amb} = -40 ^{\circ} \text{C}$  to +85  $^{\circ} \text{C}$ .

				LIMITS		
SYMBOL	PARAMETER	WAVEFORM	V <sub>C</sub>	UNIT		
			MIN	TYP <sup>1</sup>	MAX	
f <sub>MAX</sub>	Maximum clock frequency	1	150			MHz
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn or Bn to An	2	1.0 1.0	1.4 1.8	3.4 3.8	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay Clock Low or High LEAB to Bn or LEBA to An	3	1.5 1.5	2.1 2.7	3.4 4.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay CPAB to Bn or CPBA to An	1	1.0 1.0	1.9 2.7	3.2 4.4	ns
t <sub>PZH</sub>	Output enable time to High and Low level	5 6	1.0 1.0	2.0 1.4	3.1 3.6	ns
t <sub>PHZ</sub>	Output disable time from High and Low Level	5 6	2.0 2.0	2.7 2.5	4.2 4.0	ns

#### NOTE:

#### AC SETUP REQUIREMENTS (3.3V $\pm$ 0.3V RANGE)

GND = 0V;  $t_R = t_F = 2.5 \text{ns}$ ;  $C_L = 50 \text{pF}$ ;  $R_L = 500 \Omega$ ;  $T_{amb} = -40 ^{\circ} \text{C}$  to  $+85 ^{\circ} \text{C}$ .

			LIM		
SYMBOL	PARAMETER	WAVEFORM	V <sub>CC</sub> = 3.3	3V ±0.3V	UNIT
			MIN	TYP	
t <sub>S</sub> (H) t <sub>S</sub> (L)	Setup time, High or Low An to CPAB or Bn to CPBA	4	2.0 2.0	0.5 0.7	ns
t <sub>h</sub> (H) t <sub>h</sub> (L)	Hold time, High or Low An to CPAB or Bn to CPBA	4	1.0 1.0	-0.6 -0.3	ns
t <sub>S</sub> (H) t <sub>S</sub> (L)	Setup time, High or Low An to LEAB or Bn to LEBA	4	1.0 1.0	-0.6 -0.1	ns
t <sub>h</sub> (H) t <sub>h</sub> (L)	Hold time, High or Low An to LEAB or Bn to LEBA	4	1.0 1.5	0.1 0.6	ns
t <sub>W</sub> (H) t <sub>W</sub> (L)	Pulse width, High or Low CPAB or CPBA	1	2.0 2.0		ns
t <sub>W</sub> (H)	LEAB or LEBA pulse width, High	3	1.5		ns

<sup>1.</sup> All typical values are at  $V_{CC}$  = 3.3V and  $T_{amb}$  = 25°C.

# 2.5V/3.3V 18-bit universal bus transceiver (3-State)

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#### DC ELECTRICAL CHARACTERISTICS (2.5V $\pm$ 0.2V RANGE)

					LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS		Temp =	Temp = -40°C to +85°C		UNIT
				MIN	TYP <sup>1</sup>	MAX	
V <sub>IK</sub>	Input clamp voltage	$V_{CC} = 2.3V; I_{IK} = -18mA$			-0.85	-1.2	V
.,	18.1.1.1.1.1.1	$V_{CC} = 2.3 \text{ to } 3.6 \text{V}; I_{OH} = -100 \mu\text{A}$		V <sub>CC</sub> -0.2			,,
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = 2.3V; I <sub>OH</sub> = -8mA		1.8			V
		V <sub>CC</sub> = 2.3V; I <sub>OL</sub> = 100μA			0.07	0.2	
$V_{OL}$	Low-level output voltage	$V_{CC} = 2.3V; I_{OL} = 24mA$			0.3	0.5	V
		V <sub>CC</sub> = 2.3V; I <sub>OL</sub> = 8mA				0.4	
V <sub>RST</sub>	Power-up output low voltage <sup>7</sup>	$V_{CC} = 2.7V$ ; $I_O = 1mA$ ; $V_I = V_{CC}$ or GND				0.55	٧
		$V_{CC} = 2.7V$ ; $V_I = V_{CC}$ or GND	Control pins		0.1	±1	
I.	Input leakage current	$V_{CC} = 0 \text{ or } 2.7V; V_I = 5.5V$			0.1	10	
η		$V_{CC} = 2.7V; V_I = V_{CC}$	Data pins <sup>4</sup>		0.1	1	μΑ
		$V_{CC} = 2.7V; V_I = 0$	Data pins		0.1	-5	
I <sub>OFF</sub>	Off current	$V_{CC} = 0V$ ; $V_{I}$ or $V_{O} = 0$ to 4.5V			0.1	±100	μΑ
I <sub>HOLD</sub>	Bus Hold current	$V_{CC} = 2.3V; V_I = 0.7V$			90		μА
	Data inputs <sup>6</sup>	$V_{CC} = 2.3V; V_I = 1.7V$			-75		μΑ
I <sub>EX</sub>	Current into an output in the High state when V <sub>O</sub> > V <sub>CC</sub>	V <sub>O</sub> = 5.5V; V <sub>CC</sub> = 2.3V			5	125	μΑ
I <sub>PU/PD</sub>	Power up/down 3-State output current <sup>3</sup>	$V_{CC} \le 1.2V$ ; $V_O = 0.5V$ to $V_{CC}$ ; $V_I = GND$ or $V_{CC}$ ; $OE/OE = Don't$ care			4	100	μΑ
I <sub>CCH</sub>		$V_{CC} = 2.7V$ ; Outputs High, $V_I = GND$ or $V_{CC}$ , $I_{O} = 0$			0.04	0.1	
I <sub>CCL</sub>	Quiescent supply current	$V_{CC} = 2.7V$ ; Outputs Low, $V_I = GND$ or $V_{CC}$ , $I_{O} = 0$			2.5	4.5	mA
I <sub>CCZ</sub>	1	V <sub>CC</sub> = 2.7V; Outputs Disabled; V <sub>I</sub> = GNE	or V <sub>CC</sub> , I <sub>O</sub> =0 <sup>5</sup>		0.04	0.1	
Δl <sub>CC</sub>	Additional supply current per input pin <sup>2</sup>	$V_{CC}$ = 2.3V to 2.7V; One input at $V_{CC}$ -0 Other inputs at $V_{CC}$ or GND	.6V,		0.01	0.4	mA

- All typical values are at V<sub>CC</sub> = 2.5V and T<sub>amb</sub> = 25°C.
   This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND
   This parameter is valid for any V<sub>CC</sub> between 0V and 1.2V with a transition time of up to 10msec. From V<sub>CC</sub> = 1.2V to V<sub>CC</sub> = 2.5V ± 0.3V a transition time of 100µsec is permitted. This parameter is valid for T<sub>amb</sub> = 25°C only.
   Unused pins at V<sub>CC</sub> or GND.
   I<sub>CCZ</sub> is measured with outputs pulled up to V<sub>CC</sub> or pulled down to ground.
   Not guaranteed.

- 7. For valid test results, data must not be loaded into the flip-flops (or latches) after applying power.

# 2.5V/3.3V 18-bit universal bus transceiver (3-State)

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#### AC CHARACTERISTICS (2.5V $\pm$ 0.2V RANGE)

GND = 0V;  $t_R = t_F = 2.5 \text{ns}$ ;  $C_L = 50 \text{pF}$ ;  $R_L = 500 \Omega$ ;  $T_{amb} = -40 ^{\circ} \text{C}$  to +85  $^{\circ} \text{C}$ .

				LIMITS		
SYMBOL	PARAMETER	WAVEFORM	V <sub>C</sub>	UNIT		
			MIN	TYP <sup>1</sup>	MAX	
f <sub>MAX</sub>	Maximum clock frequency	1	150			MHz
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn or Bn to An	2	1.0 1.0	1.9 2.5	3.0 3.8	ns
<sup>t</sup> PLH <sup>t</sup> PHL	Propagation delay Clock Low or High LEAB to Bn or LEBA to An	3	2.0 2.0	3.0 3.5	4.5 5.4	ns
<sup>†</sup> PLH <sup>†</sup> PHL	Propagation delay CPAB to Bn or CPBA to An	1	1.0 1.0	2.9 3.7	4.9 5.7	ns
<sup>†</sup> PZH <sup>†</sup> PZL	Output enable time to High and Low level	5 6	1.5 1.5	3.1 2.1	4.5 2.9	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output disable time from High and Low Level	5 6	1.5 1.5	3.0 2.4	4.2 3.6	ns

#### NOTE:

#### AC SETUP REQUIREMENTS (2.5V $\pm$ 0.2V RANGE)

GND = 0V;  $t_R = t_F = 2.5 \text{ns}$ ;  $C_L = 50 \text{pF}$ ;  $R_L = 500 \Omega$ ;  $T_{amb} = -40 ^{\circ} \text{C}$  to  $+85 ^{\circ} \text{C}$ .

			LIM		
SYMBOL	PARAMETER	WAVEFORM	V <sub>CC</sub> = 2.5	5V ±0.2V	UNIT
			MIN	TYP	
t <sub>S</sub> (H) t <sub>S</sub> (L)	Setup time, High or Low An to CPAB or Bn to CPBA	4	1.9 2.5	0.4 1.2	ns
t <sub>h</sub> (H) t <sub>h</sub> (L)	Hold time, High or Low An to CPAB or Bn to CPBA	4	0 1.0	-1.2 -0.4	ns
t <sub>S</sub> (H) t <sub>S</sub> (L)	Setup time, High or Low An to LEAB or Bn to LEBA	4	0 1.0	-1.0 -0.5	ns
t <sub>h</sub> (H) t <sub>h</sub> (L)	Hold time, High or Low An to LEAB or Bn to LEBA	4	1.0 2.0	-0.5 1.0	ns
t <sub>W</sub> (H) t <sub>W</sub> (L)	Pulse width, High or Low CPAB or CPBA	1	3.0 3.0		ns
t <sub>W</sub> (H)	LEAB or LEBA pulse width, High	3	1.5		ns

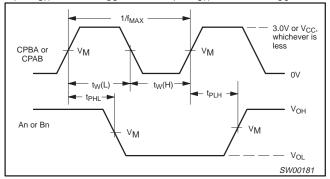
<sup>1.</sup> All typical values are at  $V_{CC}$  = 3.3V and  $T_{amb}$  = 25°C.

### 2.5V/3.3V 18-bit universal bus transceiver (3-State)

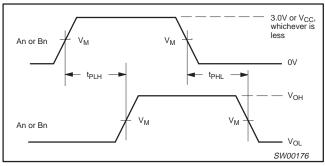
### 74ALVT16501

#### **AC WAVEFORMS**

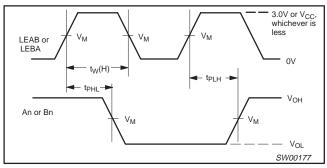
 $\begin{array}{l} V_{M} = 1.5 \text{V at V}_{CC} \geq 3.0 \text{V}, \ V_{M} = V_{CC}/2 \text{ at V}_{CC} \leq 2.7 \text{V} \\ V_{X} = V_{OL} + 0.3 \text{V at V}_{CC} \geq 3.0 \text{V}, \ V_{X} = V_{OL} + 0.150 \text{V at V}_{CC} \leq 2.7 \text{V} \\ V_{Y} = V_{OH} - 0.3 \text{V at V}_{CC} \geq 3.0 \text{V}, \ V_{Y} = V_{OH} - 0.150 \text{V at V}_{CC} \leq 2.7 \text{V} \end{array}$ 



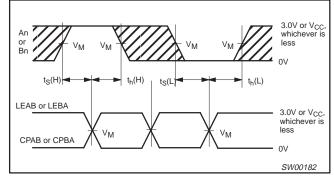
Waveform 1. Propagation Delay, Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency



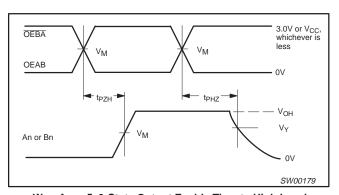
Waveform 2. Propagation Delay, Transparent Mode



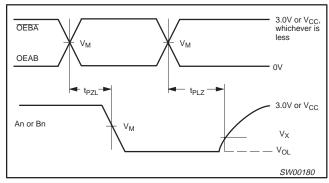
Waveform 3. Propagation Delay, Enable to Output, and Enable Pulse Width



Waveform 4. Data Setup and Hold Times



Waveform 5. 3-State Output Enable Time to High Level and Output Disable Time from High Level

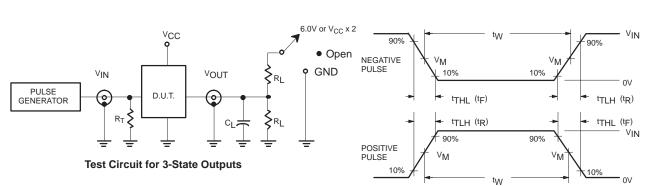


Waveform 6. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

# 2.5V/3.3V 18-bit universal bus transceiver (3-State)

74ALVT16501

#### **TEST CIRCUIT**



#### **SWITCH POSITION**

TEST	SWITCH
t <sub>PLZ</sub> /t <sub>PZL</sub>	6V or V <sub>CC x 2</sub>
t <sub>PLH</sub> /t <sub>PHL</sub>	Open
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

#### **DEFINITIONS**

R<sub>L</sub> = Load resistor; see AC CHARACTERISTICS for value.

 $\begin{aligned} \textbf{C}_L = & \text{Load capacitance includes jig and probe capacitance:} \\ & \text{See AC CHARACTERISTICS for value.} \end{aligned}$ 

 $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.

FAMILY	INPUT PULSE REQUIREMENTS								
FAMILY	Amplitude	Rep. Rate	t <sub>W</sub>	t <sub>R</sub>	t <sub>F</sub>				
74ALVT16	3.0V or V <sub>CC</sub> whichever is less	≤10MHz	500ns	≤2.5ns	≤2.5ns				

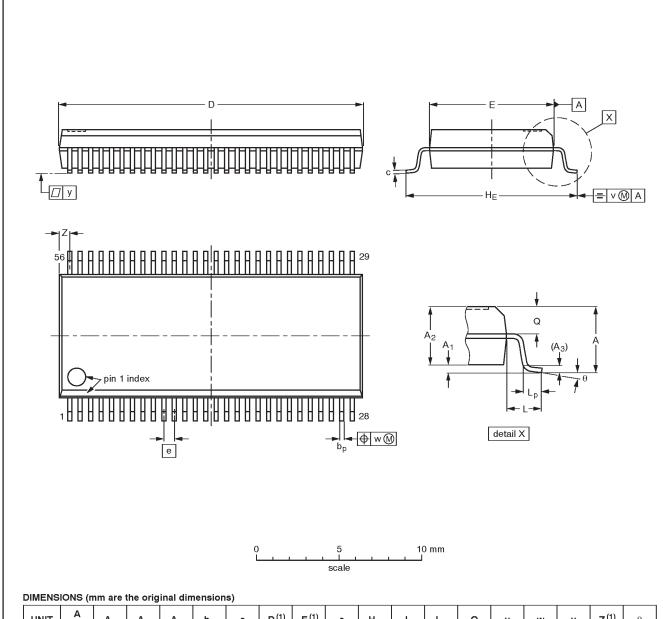
SW00220

# 2.5V/3.3V 18-bit universal bus transceiver (3-State)

### 74ALVT16501

#### SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1



UNIT	A max.	Α <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	18.55 18.30	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

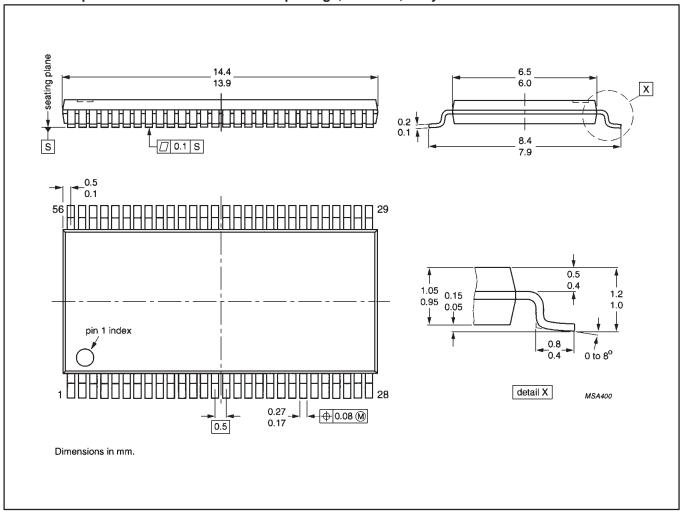
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT371-1		MO-118AB				<del>93-11-02</del> 95-02-04

# 2.5V/3.3V 18-bit universal bus transceiver (3-State)

74ALVT16501

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



2.5V/3.3V 18-bit universal bus transceiver (3-State)

74ALVT16501

NOTES

### 2.5V/3.3V 18-bit universal bus transceiver (3-State)

74ALVT16501

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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